

## **MOSFET**

## OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V

### **Features**

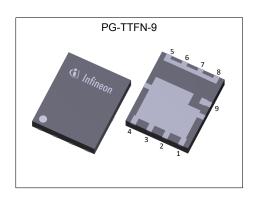
- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
   Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

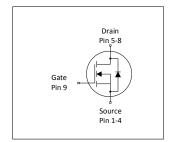
### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

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Parameter	Value	Unit						
$V_{ t DS}$	80	V						
$R_{ extsf{DS(on),max}}$	1.57	mΩ						
I <sub>D</sub>	323	A						
Qoss	123	nC						
$Q_{G}$	106	nC						











Type / Ordering Code	Package	Marking	Related Links
IQD016N08NM5CG	PG-TTFN-9	01608NC	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V



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## OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V IQD016N08NM5CG



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	Ob. a.l	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	323 229 188 31	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1292	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	<b>E</b> AS	-	-	802	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	333 3.0	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 °C/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	-

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Baramatar	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	50	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V IQD016N08NM5CG



## 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	80	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	2.2	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 159 \ \mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	1.4 1.9	1.57 2.32	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A V <sub>GS</sub> =6 V, I <sub>D</sub> =50 A
Gate resistance	R <sub>G</sub>	-	0.35	-	Ω	-
Transconductance	<b>g</b> fs	70	140	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 Dynamic characteristics

Parameter	O. mak al	Values			11:4	Nata / Tank Oam distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	7100	9200	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	1200	1600	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	56	98	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	15	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	7	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	29	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	10	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Oh. a.l.		Values			Nata / Tank One William
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	31	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	21	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	$Q_{ m gd}$	-	25	38	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	35	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	<b>Q</b> g	-	106	133	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	4.4	-	V	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	90	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Qoss	-	123	164	nC	V <sub>DS</sub> =40 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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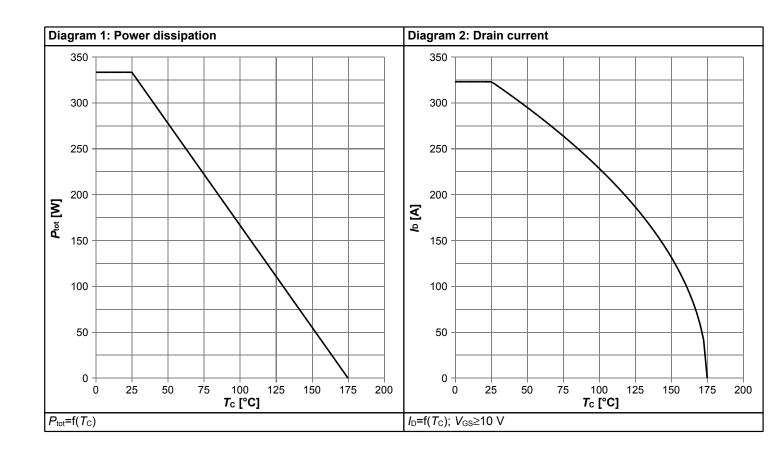


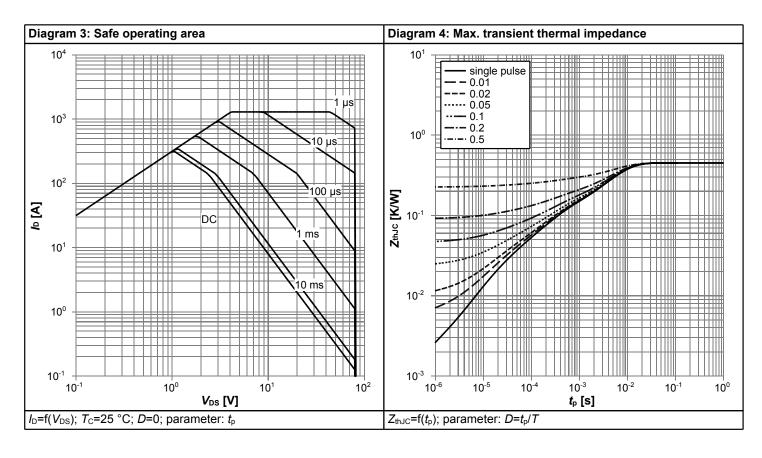
## Table 7 Reverse diode

Parameter	C: mah al		Values			Nata / Table Open Hittag
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	252	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	1292	Α	T <sub>C</sub> =25 °C
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.82	1.0	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	<i>t</i> <sub>rr</sub>	-	48	96	ns	V <sub>R</sub> =40 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs
Reverse recovery charge <sup>1)</sup>	Qrr	-	71	142	nC	V <sub>R</sub> =40 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

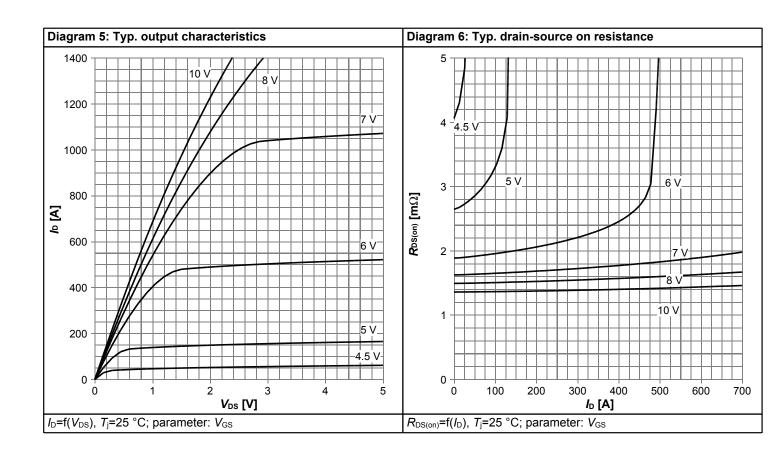


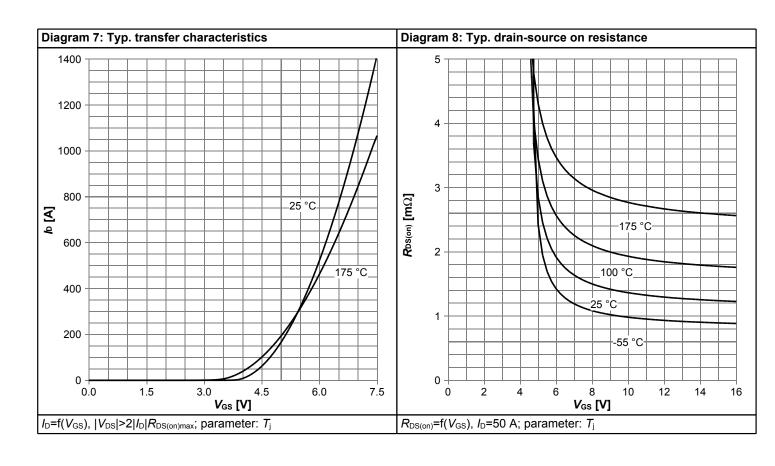
# 4 Electrical characteristics diagrams



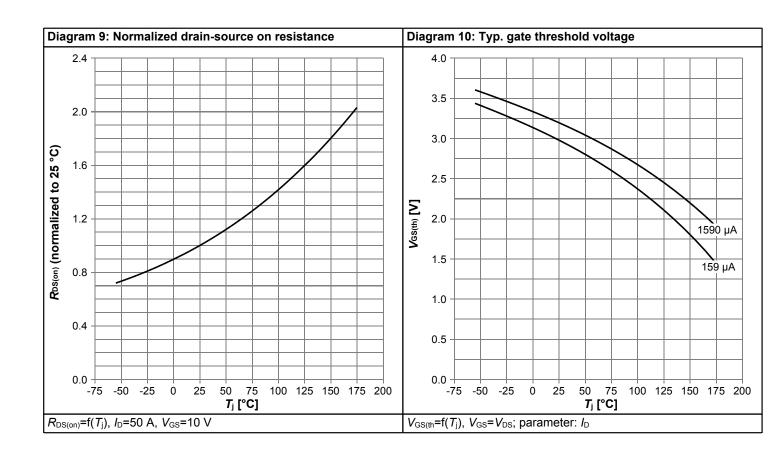


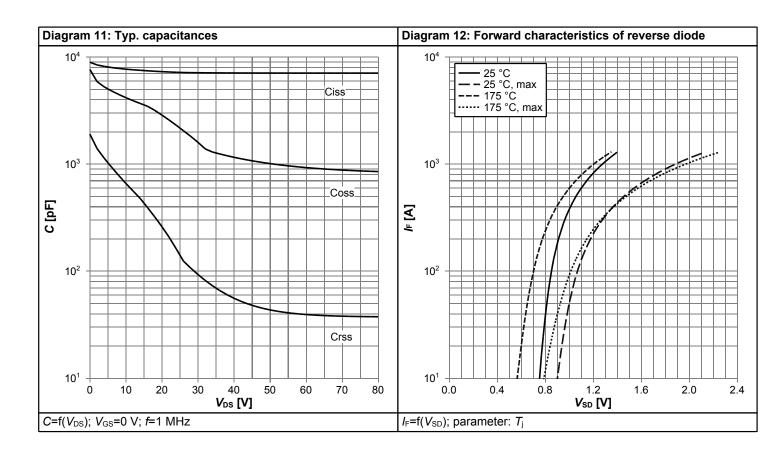




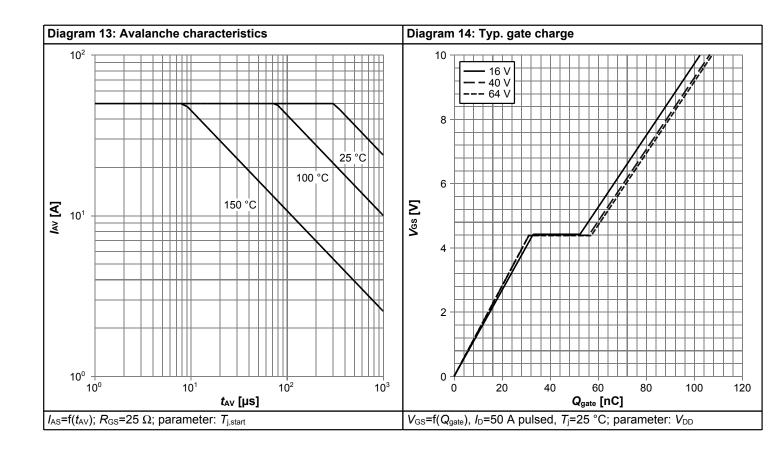


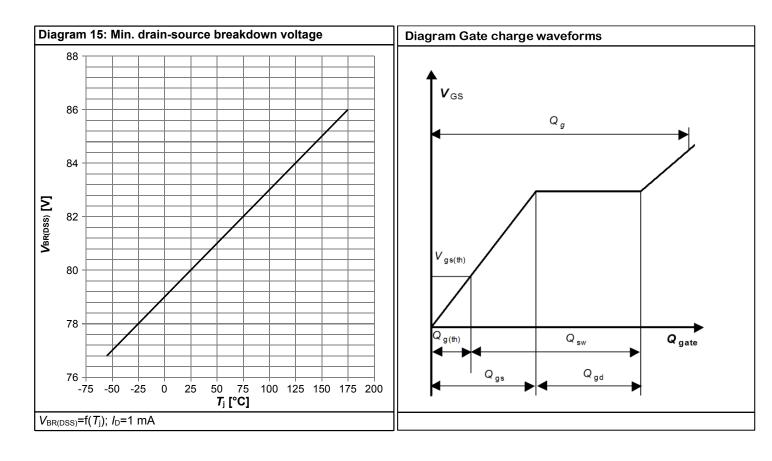














# 5 Package Outlines

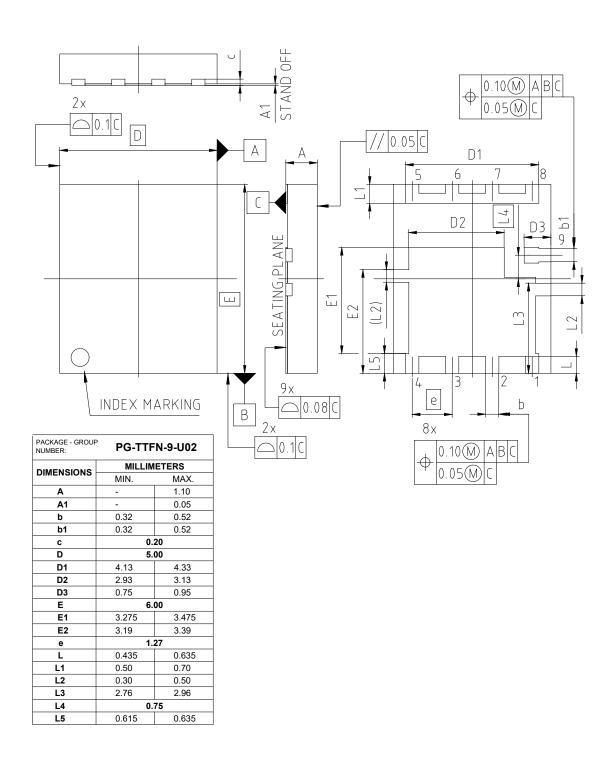


Figure 1 Outline PG-TTFN-9, dimensions in mm

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### **Revision History**

IQD016N08NM5CG

Revision: 2023-04-04, Rev. 2.1

Previous Revision

	Troviduo Novicion							
Revision	vision Date Subjects (major changes since last revision)							
2.0	2023-03-08	Release of final version						
2.1	2023-04-04	Update RG,ext for switching times						

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